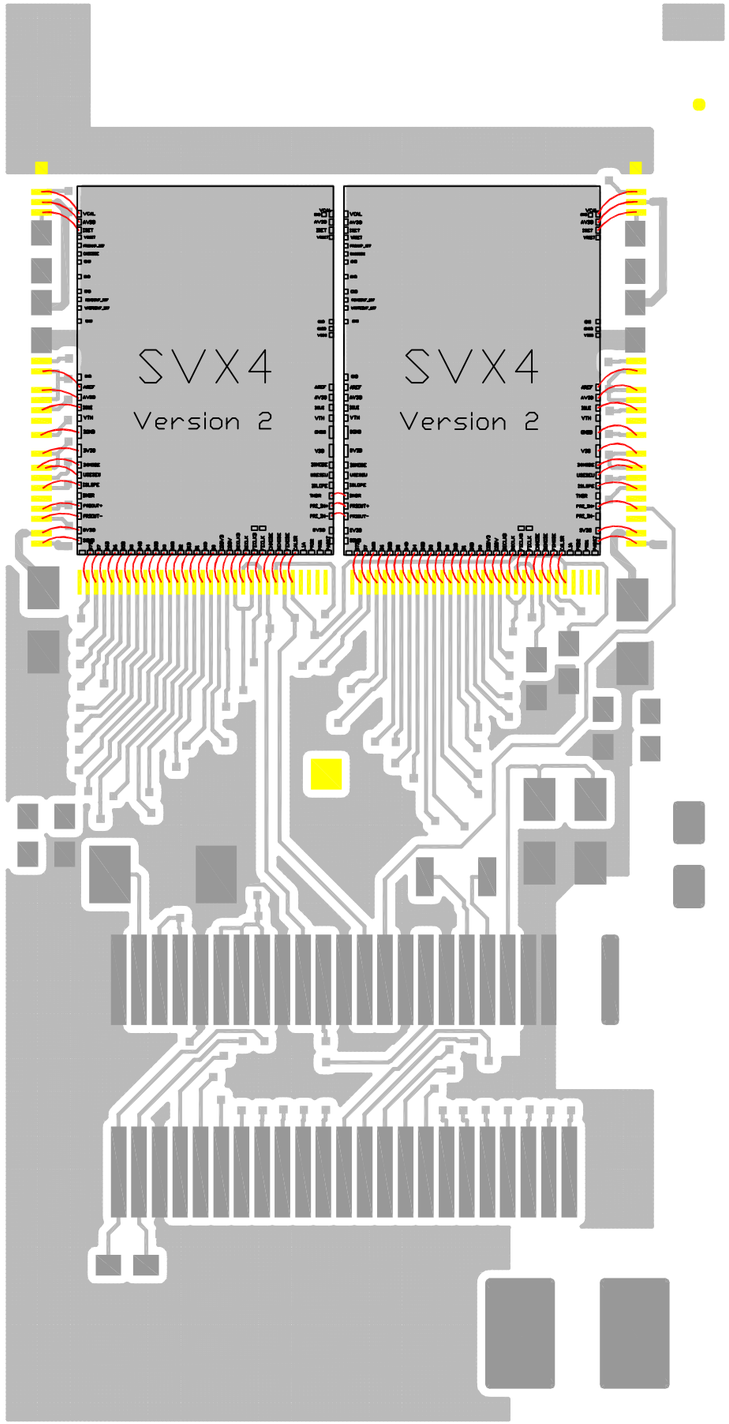
REV.	DESCRIPTION	DRAWN	DATE
		APPD.	DATE



NOTES:

1. THIS DRAWING CORRESPONDS TO HYBRID 173478 REVB2 2/6/2004.
2. RED LINES INDICATE POSITION OF WIRE BONDS.
3. THIS DIAGRAM FOR SVX4-2B CHIPS ONLY.

ITEM	PART NO.	DESCRIPTION OR SIZE	QTY.
PARTS LIST			

UNLESS OTHERWISE SPEC.					
FRACTIONS	DECIMALS	ANGLES	ORIGINATOR	M. UTES	2/11/4
			DRAWN	M. UTES	2/11/4
			CHECKED		
			APPROVED		
			USED ON		
			MATERIAL–		

FERMI NATIONAL ACCELERATOR LABORATORY
UNITED STATES DEPARTMENT OF ENERGY

L0 HYBRID BONDING DIAGRAM

SCALE	FILMED	DRAWING NUMBER	REV.
7:1		3823.112-MC-330386	301